

# Trench gate field-stop IGBT M series, 650 V, 15 A low-loss in a TO-220 package

Datasheet - production data

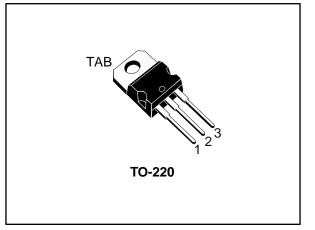
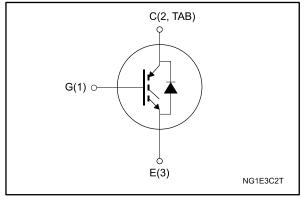


Figure 1: Internal schematic diagram



### Features

- 6 µs of short-circuit withstand time
- V<sub>CE(sat)</sub> = 1.55 V (typ.) @ I<sub>C</sub> = 15 A
- Tight parameter distribution
- Safer paralleling
- Positive V<sub>CE(sat)</sub> temperature coefficient
- Low thermal resistance
- Soft and very fast recovery antiparallel diode
- Maximum junction temperature: T<sub>J</sub> = 175 °C

#### Applications

- Motor control
- UPS
- PFC
- General purpose inverter

### Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where low-loss and short-circuit functionality are essential. Furthermore, the positive  $V_{CE(sat)}$  temperature coefficient and tight parameter distribution result in safer paralleling operation.

Order code	Marking	Package	Packing
STGP15M65DF2	G15M65DF2	TO-220	Tube

This is information on a product in full production.

#### Contents

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### 1 Electrical ratings

 Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
VCES	Collector-emitter voltage (V <sub>GE</sub> = 0 V)	650	V
1.	Continuous collector current at T <sub>C</sub> = 25 °C	30	А
lc	Continuous collector current at T <sub>c</sub> = 100 °C	15	А
ICP <sup>(1)</sup>	Pulsed collector current	60	А
V <sub>GE</sub>	Gate-emitter voltage	±20	V
IF	Continuous forward current at T <sub>C</sub> = 25 °C	30	А
lF	Continuous forward current at T <sub>c</sub> = 100 °C		А
I <sub>FP</sub> <sup>(1)</sup>	Pulsed forward current 60		А
Ртот	Total dissipation at $T_c = 25 \ ^{\circ}C$	136	W
Tstg	Storage temperature range - 55 to 150		°C
TJ	Operating junction temperature range	- 55 to 175	°C

#### Notes:

 $^{(1)}\mbox{Pulse}$  width limited by maximum junction temperature.

#### Table 3: Thermal data

Symbol	Parameter Value			
RthJC	Thermal resistance junction-case IGBT	1.1	°C/W	
RthJC	Thermal resistance junction-case diode 2.08		°C/W	
R <sub>thJA</sub>	Thermal resistance junction-ambient	62.5	°C/W	



### 2 Electrical characteristics

 $T_J = 25 \ ^{\circ}C$  unless otherwise specified.

I able 4: Static characteristics						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)CES</sub>	Collector-emitter breakdown voltage	$V_{GE} = 0 V, I_C = 250 \mu A$	650			V
		$V_{GE}$ = 15 V, I <sub>C</sub> = 15 A		1.55	2.0	
V <sub>CE(sat)</sub> Collector- voltage	Collector-emitter saturation	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 15 A T <sub>J</sub> = 125 °C		1.9		V
	Voltago	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 15 A T <sub>J</sub> = 175 °C		2.1		
		I⊧ = 15 A		1.7	2.6	V
VF	Forward on-voltage	I <sub>F</sub> = 15 A T <sub>J</sub> = 125 °C		1.5		V
		I <sub>F</sub> = 15 A T <sub>J</sub> = 175 °C		1.4		V
V <sub>GE(th)</sub>	Gate threshold voltage	$V_{CE} = V_{GE}$ , $I_C = 500 \ \mu A$	5	6	7	V
ICES	Collector cut-off current	$V_{GE} = 0 V, V_{CE} = 650 V$			25	μA
IGES	Gate-emitter leakage current	$V_{CE} = 0 \text{ V}, \text{ V}_{GE} = \pm 20 \text{ V}$			±250	μA

#### Table 4: Static characteristics

#### Table 5: Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance		-	1250	-	pF
Coes	Output capacitance	V <sub>CE</sub> = 25 V, f = 1 MHz, V <sub>GE</sub> = 0 V	-	80	-	pF
Cres	Reverse transfer capacitance		-	25	-	pF
Qg	Total gate charge	$V_{CC} = 520 \text{ V}, \text{ I}_{C} = 15 \text{ A},$	-	45	-	nC
Q <sub>ge</sub>	Gate-emitter charge	V <sub>GE</sub> = 0 to 15 V (see <i>Figure 30:</i> " <i>Gate</i>	-	11	-	nC
Q <sub>gc</sub>	Gate-collector charge	charge test circuit"	-	15	-	nC



#### Electrical characteristics

	Table 6: IGBT switching characteristics (inductive load)					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time			24	-	ns
tr	Current rise time			7.8	-	ns
(di/dt) <sub>on</sub>	Turn-on current slope	V <sub>CE</sub> = 400 V, I <sub>C</sub> = 15 A,		1570	-	A/µs
$t_{d(off)}$	Turn-off delay time	$V_{GE} = 15 \text{ V}, \text{ R}_{G} = 12 \Omega$		93	-	ns
t <sub>f</sub>	Current fall time	(see Figure 29: " Test circuit		106	-	ns
Eon <sup>(1)</sup>	Turn-on switching energy	for inductive load switching")		0.09	-	μJ
E <sub>off</sub> <sup>(2)</sup>	Turn-off switching energy			0.45	-	μJ
Ets	Total switching energy			0.54	-	μJ
t <sub>d(on)</sub>	Turn-on delay time			24.8	-	ns
tr	Current rise time			9.2	-	ns
(di/dt) <sub>on</sub>	Turn-on current slope	V <sub>CE</sub> = 400 V, I <sub>C</sub> = 15 A,		1300	-	A/µs
t <sub>d(off)</sub>	Turn-off delay time	R <sub>G</sub> = 15 Ω, V <sub>GE</sub> = 15 V, T <sub>-</sub> I = 175 °C		96	-	ns
t <sub>f</sub>	Current fall time	(see Figure 29: " Test circuit		169	-	ns
Eon <sup>(1)</sup>	Turn-on switching energy	for inductive load switching")		0.22	-	μJ
E <sub>off</sub> <sup>(2)</sup>	Turn-off switching energy			0.61	-	μJ
E <sub>ts</sub>	Total switching energy			0.83	-	μJ
+	Short circuit withstand time	V <sub>CC</sub> ≤ 400 V, V <sub>GE</sub> = 15 V, T <sub>Jstart</sub> = 150 °C	6		-	
t <sub>sc</sub>	Short-circuit withstand time	V <sub>CC</sub> ≤ 400 V, V <sub>GE</sub> = 13 V, T <sub>Jstart</sub> = 150 °C	10		-	μs

#### Notes:

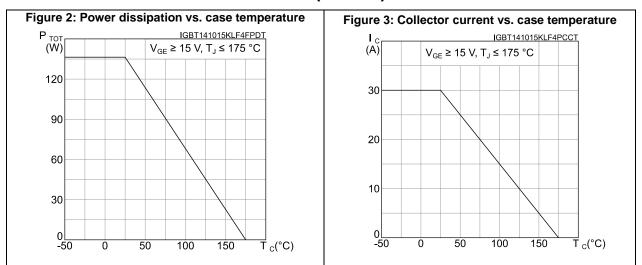
<sup>(1)</sup>Including the reverse recovery of the diode. <sup>(2)</sup>Including the tail of the collector current.

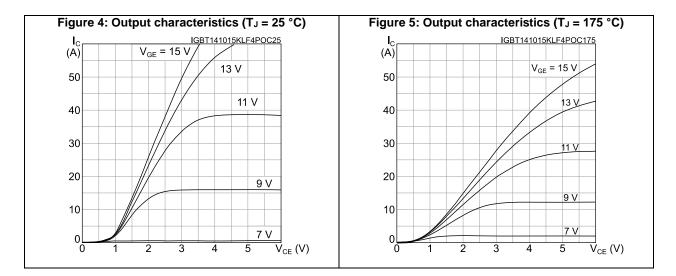
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
trr	Reverse recovery time		-	142	-	ns
Qrr	Reverse recovery charge	$I_F = 15 \text{ A}, V_R = 400 \text{ V},$	-	525	-	nC
Irrm	Reverse recovery current	V <sub>GE</sub> = 15 V, di/dt = 1000 A/µs	-	13.4	-	Α
dlrr//dt	Peak rate of fall of reverse recovery current during t <sub>b</sub>	(see Figure 29: " Test circuit for inductive load switching")	-	790	-	A/µs
Err	Reverse recovery energy		-	64	-	μJ
t <sub>rr</sub>	Reverse recovery time		-	241	-	ns
Qrr	Reverse recovery charge	IF = 15 A, VR = 400 V, VGE = 15 V,	-	1690	-	nC
Irrm	Reverse recovery current	di/dt = 1000 A/µs,	-	20	-	Α
dlrr//dt	Peak rate of fall of reverse recovery current during t <sub>b</sub>	T <sub>J</sub> = 175 °C (see Figure 29: " Test circuit for inductive load switching")	-	420	-	A/µs
Err	Reverse recovery energy	······································	-	176	-	μJ

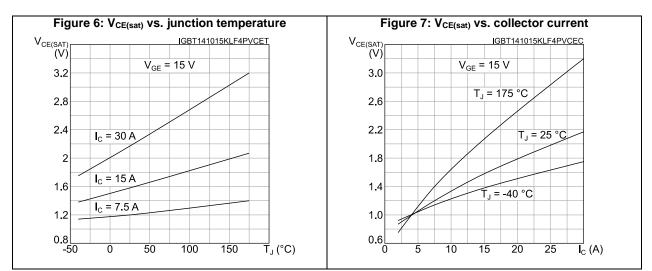
Table 7: Diode switching	characteristics	(inductive load)	•
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### 2.1 Electrical characteristics (curves)



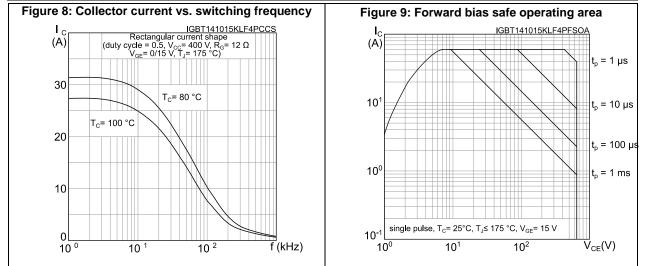


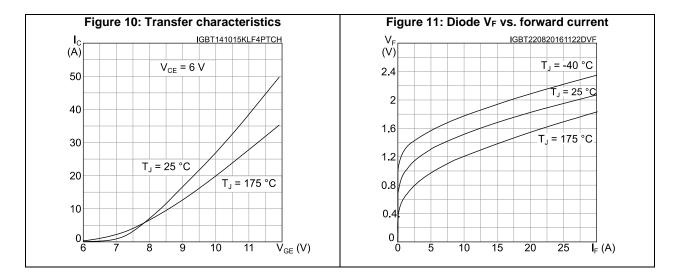


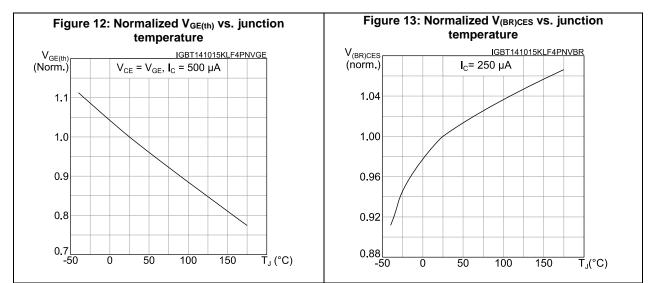


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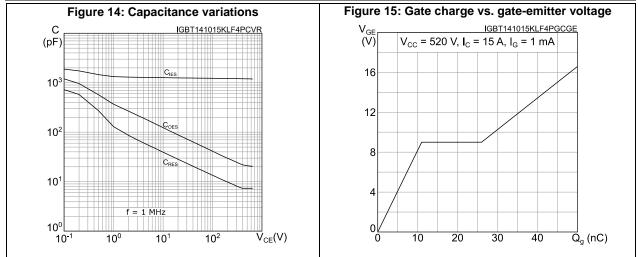
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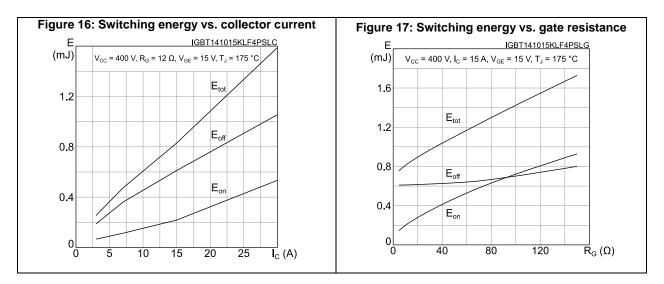


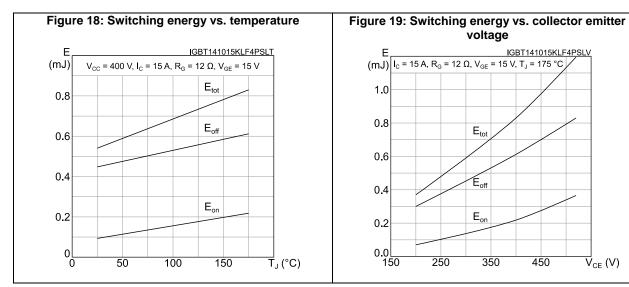








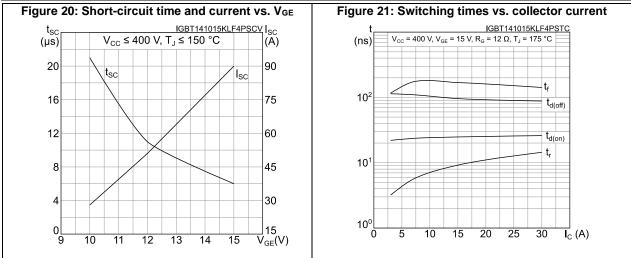


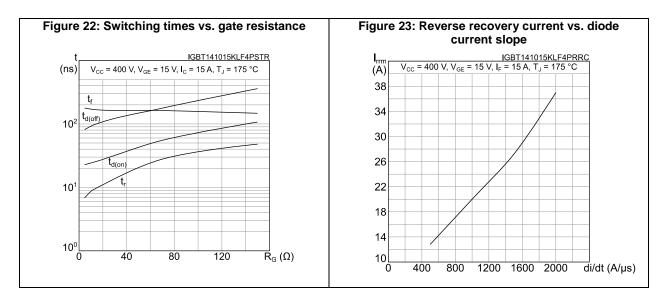


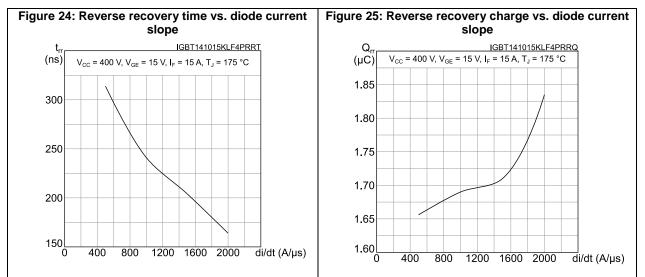


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#### **Electrical characteristics**

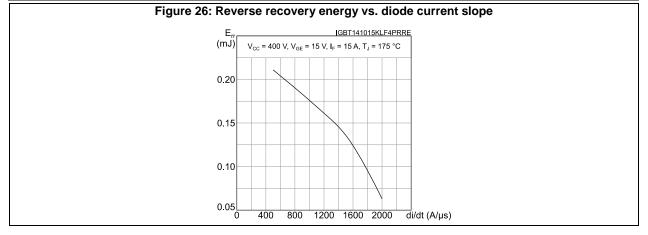


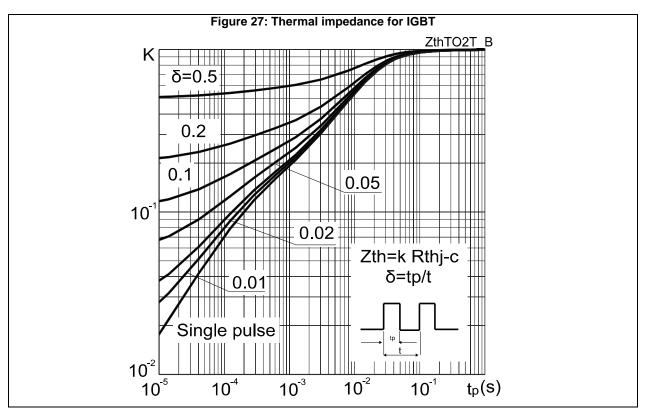




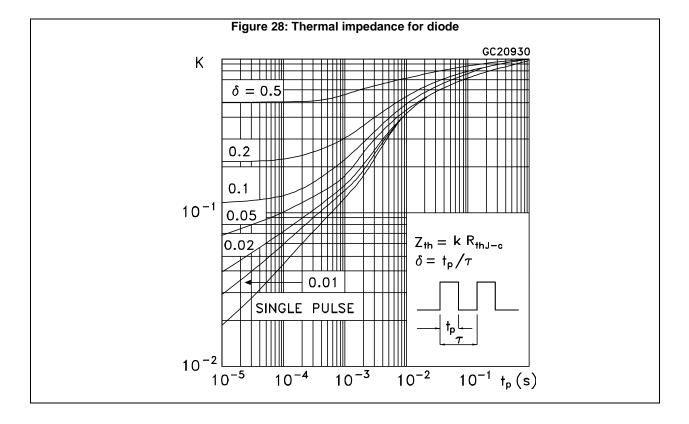
#### **Electrical characteristics**

#### STGP15M65DF2



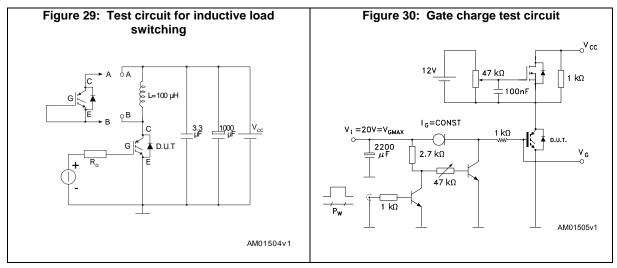


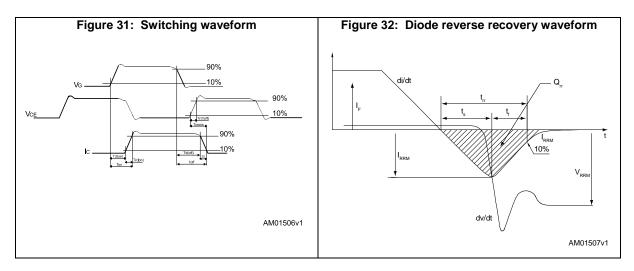






### 3 Test circuits





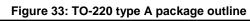


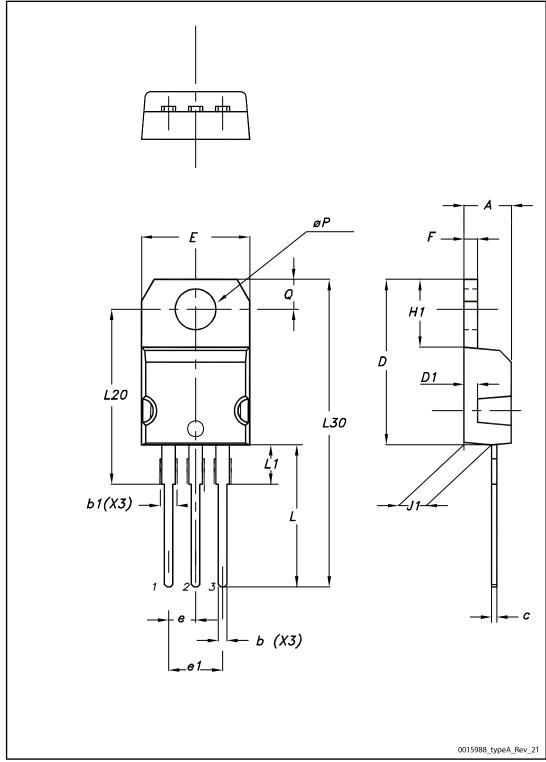
### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.











65DF2			Package information	
Table 8: TO-220 type A package mechanical data				
Dim		mm		
Dim.	Min.	Тур.	Max.	
A	4.40		4.60	
b	0.61		0.88	
b1	1.14		1.55	
С	0.48		0.70	
D	15.25		15.75	
D1		1.27		
E	10.00		10.40	
e	2.40		2.70	
e1	4.95		5.15	
F	1.23		1.32	
H1	6.20		6.60	
J1	2.40		2.72	
L	13.00		14.00	
L1	3.50		3.93	
L20		16.40		
L30		28.90		
øP	3.75		3.85	
Q	2.65		2.95	



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#### **Revision history** 5

Table 9: Document revision history

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Date	Revision	Changes
14-Oct-2015	1	First release.
13-Nov-2015	2	Document status promoted from preliminary to production data.
22-Aug-2016	3	Updated Table 2: "Absolute maximum ratings" and Table 6: "IGBT switching characteristics (inductive load)". Updated Figure 16: "Switching energy vs. collector current", Figure 17: "Switching energy vs. gate resistance", Figure 18: "Switching energy vs. temperature" and Figure 19: "Switching energy vs. collector emitter voltage". Changed Figure 11: "Diode VF vs. forward current".
28-Apr-2017	4	Modified: title, features and applications on cover page. Modified <i>Table 4: "Static characteristics", Table 5: "Dynamic characteristics", Table 7: "Diode switching characteristics (inductive load)".</i> Minor text changes.



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